



Electronic Filing System (EFS) Data
Electronic Patent Application Submission
USPTO Use Only

EFS ID: 53407

Application ID: 10675258



Title of Invention: Aluminum Pad Power Bus and
Signal Routing for Integrated
Circuit Devices Utilizing Copper
Technology Interconnect
Structures

First Named Inventor: Seung Kang

Domestic/Foreign Application: Domestic Application

Filing Date: 2003-09-30

Effective Receipt Date: 2004-01-09

Submission Type: Information Disclosure
Statement

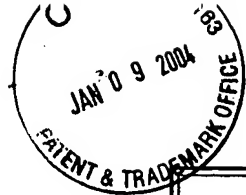
Filing Type:

Confirmation number: 4017

Attorney Docket Number: 075903-218

Total Fees Authorized:


Digital Certificate Holder: cn=John L. DeAngelis,ou=Registered Attorneys,ou=Patent and
Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US
Certificate Message Digest: 87074e4665676cd9ed0d8d8899c04c54747781c3



TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0


Title of Invention	Aluminum Pad Power Bus and Signal Routing for Integrated Circuit Devices Utilizing Copper Technology Interconnect Structures									
Application Number: 10/675258 										
Date: 2003-09-30										
First Named Applicant: Seung H. Kang										
Confirmation Number: 4017										
Attorney Docket Number: 075903-218										
<p>I hereby certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.</p> <p>I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.</p>										
<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>John L. DeAngelis Jr. Registered Number: 30,622</td><td>/John L. DeAngelis, Jr./</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	John L. DeAngelis Jr. Registered Number: 30,622	/John L. DeAngelis, Jr./	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
John L. DeAngelis Jr. Registered Number: 30,622	/John L. DeAngelis, Jr./	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>Agere218-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	Agere218-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	Agere218-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Aluminum Pad Power Bus and Signal Routing for Integrated Circuit Devices Utilizing Copper Technology Interconnect Structures																												
<p>Application Number: 10/675258 </p> <p>Confirmation Number: 4017</p> <p>First Named Applicant: Seung Kang</p> <p>Attorney Docket Number: 075903-218</p> <p>Art Unit: 2816</p> <p>Search string: (5148263 or 6225207).pn.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>5148263</td><td>1992-09-15</td><td>Hamai</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>6225207</td><td>2001-05-01</td><td>Parikh</td><td></td><td></td><td></td></tr></tbody></table> <p>Signature</p> <table border="1"><thead><tr><th>Examiner Name</th><th>Date</th></tr></thead><tbody><tr><td></td><td></td></tr></tbody></table>		init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	5148263	1992-09-15	Hamai					2	6225207	2001-05-01	Parikh				Examiner Name	Date		
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass																						
	1	5148263	1992-09-15	Hamai																									
	2	6225207	2001-05-01	Parikh																									
Examiner Name	Date																												